

**MAXIM**

# **±15kV ESD-Protected, RS-232 Transceivers for Multidrop Applications**

## **General Description**

The MAX3322E/MAX3323E 3.0V to 5.5V powered EIA/TIA-232 and V.28/V.24 communications interfaces are designed for multidrop applications with low power requirements, high data-rate capabilities, and enhanced electrostatic discharge (ESD) protection. All RS-232 inputs and outputs are protected to  $\pm 15\text{kV}$  using the IEC 1000-4-2 Air-Gap Discharge method,  $\pm 8\text{kV}$  using the IEC 1000-4-2 Contact Discharge method, and  $\pm 15\text{kV}$  using the Human Body Model.

The MAX3322E/MAX3323E have pin-selectable  $5\text{k}\Omega$ /high-impedance RS-232 receivers. These devices are capable of receiving data in high-impedance mode. In multidrop applications, one receiver has a  $5\text{k}\Omega$  input resistance, while the other receivers are high impedance to ensure the RS-232 standard is observed. Logic control permits selection of the functional mode: high impedance or RS-232 standard load. The transmitters are enabled by logic control to allow the multiplexing of the inputs to a single UART.

A proprietary low-dropout transmitter output stage enables true RS-232 performance from a 3.0V to 5.5V supply with a dual charge pump. The charge pump requires only four small 0.1 $\mu\text{F}$  capacitors for operation from a 3.3V supply. The MAX3322E/MAX3323E are capable of running at data rates up to 250kbps while maintaining RS-232-compliant output levels. The MAX3322E/MAX3323E have a unique  $V_L$  pin that allows operation in mixed-logic voltage systems. Both input and output logic levels are pin programmable through the  $V_L$  pin.

The MAX3322E is a 2Tx/2Rx device for hardware handshaking in standard RS-232 mode, and the MAX3323E is a 1Tx/1Rx, required in most multidrop applications.

The MAX3322E is offered in a space-saving TSSOP package. The MAX3323E is offered in 16-pin DIP and space-saving TSSOP packages.

## **Applications**

- Bar-Code Scanners
- Video Security
- Industrial Data Acquisition
- Data Splitters

*Typical Operating Circuit and Functional Diagram appear at end of data sheet.*

## **Features**

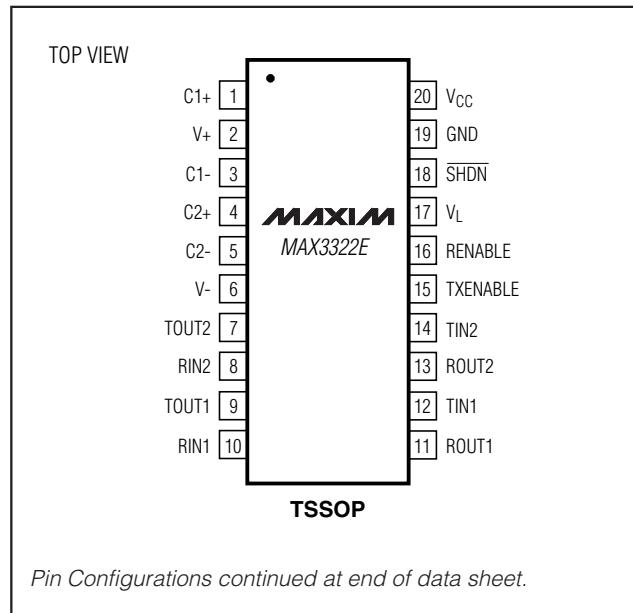
- ◆ Pin-Selectable  $5\text{k}\Omega$ /High-Impedance Receivers
- ◆ Transmitter Outputs Three-Stated by Logic Control
- ◆  $V_L$  Pin for Compatibility with Mixed Voltage Systems
- ◆ 1Tx/1Rx (MAX3323E) or 2Tx/2Rx (MAX3322E) Versions
- ◆ 250kbps Data Rate
- ◆ 1 $\mu\text{A}$  Low-Power Shutdown
- ◆ High ESD Protection for RS-232 I/O Pins
  - $\pm 15\text{kV}$ —Human Body Model
  - $\pm 8\text{kV}$ —IEC 1000-4-2 Contact Discharge
  - $\pm 15\text{kV}$ —IEC 1000-4-2 Air-Gap Discharge

**MAX3322E/MAX3323E**

## **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
<b>MAX3322E</b> EUP	-40°C to +85°C	20 TSSOP
<b>MAX3323E</b> EUE	-40°C to +85°C	16 TSSOP
MAX3323EEPE	-40°C to +85°C	16 DIP

## **Pin Configurations**

**MAXIM**

Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at [www.maxim-ic.com](http://www.maxim-ic.com).

# ***±15kV ESD-Protected, RS-232 Transceivers for Multidrop Applications***

## **ABSOLUTE MAXIMUM RATINGS**

All Voltages Referenced to GND

$V_{CC}$ , $V_L$	.....	-0.3V to +6V
$V_+$ (Note 1)	.....	( $V_{CC}$ - 0.3V) to +7V
$V_-$ (Note 1)	.....	+0.3V to -7V
$V_+ + IV_1$ (Note 1)	.....	+13V
Input Voltages		
$T_{IN}$ , RENABLE, TXENABLE, $\overline{SHDN}$	.....	-0.3V to +6V
$R_{IN}$	.....	±25V
Output Voltages		
$T_{OUT}$	.....	±13.2V
$R_{OUT}$	.....	-0.3V to ( $V_L$ + 0.3V)

**Note 1:**  $V_+$  and  $V_-$  can have maximum magnitudes of 7V, but their absolute difference cannot exceed 13V.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **DC ELECTRICAL CHARACTERISTICS**

( $V_{CC}$  = 3.0V to 5.5V,  $V_L$  = 1.65V to 5.5V, C1–C4 = 0.1 $\mu$ F, tested at +3.3V ±10%; C1 = 0.047 $\mu$ F, C2 = C3 = C4 = 0.33 $\mu$ F, tested at +5V ±10%;  $T_A$  =  $T_{MIN}$  to  $T_{MAX}$ . Typical values are at  $V_{CC}$  =  $V_L$  = 3.3V and  $T_A$  = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
<b>DC CHARACTERISTICS</b>						
Supply Current Normal Operation	$I_{CC}$	$\overline{SHDN} = V_L$ , no load	1			mA
Supply Current in Shutdown	$I_{CC}(\overline{SHDN})$	$\overline{SHDN} = 0V$ , no load	1	10		$\mu$ A
<b>TRANSMITTER LOGIC INPUTS</b>						
Input Logic Threshold Low				0.4		V
Input Logic Threshold High		$V_L \leq 1.8V$	$V_L - 0.4$			V
		$V_L > 1.8V$	$2/3 \times V_L$			
Transmitter Input Hysteresis				0.2		V
Input Leakage Current	$I_{IL}$			±0.01	±1	$\mu$ A
<b>LOGIC INPUTS (TXENABLE, RENABLE, SHDN)</b>						
Input Logic Threshold Low				0.4		V
Input Logic Threshold High			$2/3 \times V_L$			V
Input Leakage Current				±0.01	±1	$\mu$ A
<b>RECEIVER OUTPUTS</b>						
Output Leakage Current	$I_{OL}$	Receivers disabled, $\overline{SHDN} = 0V$		±0.05	±10	$\mu$ A
Output Voltage Low	$V_{OL}$	$I_{OUT} = 1.6mA$ , $V_L > 1.8V$		0.4		V
		$I_{OUT} = 1mA$ , $V_L \leq 1.8V$		0.4		
Output Voltage High	$V_{OH}$	$I_{OUT} = -1mA$ , $V_L > 1.8V$	$V_L - 0.4$	$V_L - 0.1$		V
		$I_{OUT} = -500\mu A$ , $V_L \leq 1.8V$	$V_L - 0.4$	$V_L - 0.1$		
<b>RECEIVER INPUTS</b>						
Input Voltage Range	$V_{RIN}$			-25	+25	V
Input Threshold Low		$V_L = 1.65V$		0.25	0.6	V
		$V_L = 3.3V$		0.6	1.2	
		$V_L = 5.0V$		0.8	1.5	

# ***±15kV ESD-Protected, RS-232 Transceivers for Multidrop Applications***

## **DC ELECTRICAL CHARACTERISTICS (continued)**

( $V_{CC} = 3.0V$  to  $5.5V$ ,  $V_L = 1.65V$  to  $5.5V$ ,  $C1-C4 = 0.1\mu F$ , tested at  $+3.3V \pm 10\%$ ;  $C1 = 0.047\mu F$ ,  $C2 = C3 = C4 = 0.33\mu F$ , tested at  $+5V \pm 10\%$ ;  $T_A = T_{MIN}$  to  $T_{MAX}$ . Typical values are at  $V_{CC} = V_L = 3.3V$  and  $T_A = +25^\circ C$ , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Threshold High		$V_L = 1.65V$		1	1.4	V
		$V_L = 3.3V$		1.5	2.4	
		$V_L = 5.0V$		1.8	2.4	
Input Hysteresis				0.35		V
Input Resistance	$R_{IN}$	$RENABLE = 1$	3	5	7	$k\Omega$
		$RENABLE = 0$ or $\overline{SHDN} = 0V$ , $R_{IN}$ from $-13V$ to $+13V$	1			$M\Omega$
<b>TRANSMITTER OUTPUTS</b>						
Output Voltage Swing		All transmitter outputs loaded with $3k\Omega$ to ground	$\pm 5$	$\pm 5.4$		V
Output Resistance		$V_{CC} = V_+ = V_- = 0$ , $TOUT_- = \pm 2V$ , $TXENABLE = 1$	300	10M		$\Omega$
Output Short-Circuit Current		$V_{OUT} = 0V$		$\pm 60$		$mA$
Output Leakage Current		$V_{OUT} = \pm 12V$ , transmitters disabled		$\pm 25$		$\mu A$
<b>ESD PROTECTION</b>						
RIN, TOUT		Human Body Model		$\pm 15$		kV
		IEC 1000-4-2 Air-Gap Discharge		$\pm 15$		
		IEC 1000-4-2 Contact Discharge		$\pm 8$		

## **TIMING CHARACTERISTICS**

( $V_{CC} = 3.0V$  to  $5.5V$ ,  $V_L = 1.65V$  to  $5.5V$ ,  $C1-C4 = 0.1\mu F$ , tested at  $+3.3V \pm 10\%$ ;  $C1 = 0.047\mu F$ ,  $C2 = C3 = C4 = 0.33\mu F$ , tested at  $+5V \pm 10\%$ ;  $T_A = T_{MIN}$  to  $T_{MAX}$ . Typical values are at  $V_{CC} = V_L = 3.3V$  and  $T_A = +25^\circ C$ , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Maximum Data Rate		$R_L = 3k\Omega$ , $C_L = 1000pF$ , one transmitter switching	250			kbps
Receiver Propagation Delay	$t_{PHL}$	$R_{IN\_to\ ROUT\_}$ , $C_L = 30pF$ , $V_L = 3.3V$ , Figure 2		150		ns
	$t_{PLH}$			180		
Transmitter Propagation Delay	$t_{PHL}$	$TIN\_to\ TOUT\_$ , $R_L = 3k\Omega$ , $C_L = 1000pF$ , Figure 1		0.6		$\mu s$
	$t_{PLH}$			0.7		
Time to Enter Three-State on Tx		(Note 2)		10	50	$\mu s$
Time to Exit Three-State on Tx		(Note 2)		3	50	$\mu s$
Time to Enable Resistor		(Note 2)		0.4	10	$\mu s$
Time to Disable Resistor		(Note 2)		0.2	10	$\mu s$
Time to Enter Shutdown				50		$\mu s$
Time to Exit Shutdown				50		$\mu s$
Transmitter Skew				100		ns
Receiver Skew				30		ns
Transition Region Slew Rate		$R_L = 3k\Omega$ to $7k\Omega$ , $C_L = 1000pF$ , measured from $+3V$ to $-3V$ or vice versa	6	30		$V/\mu s$

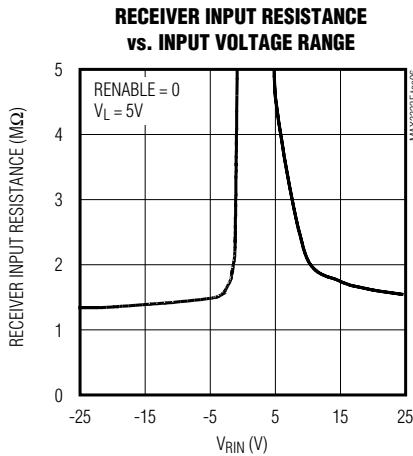
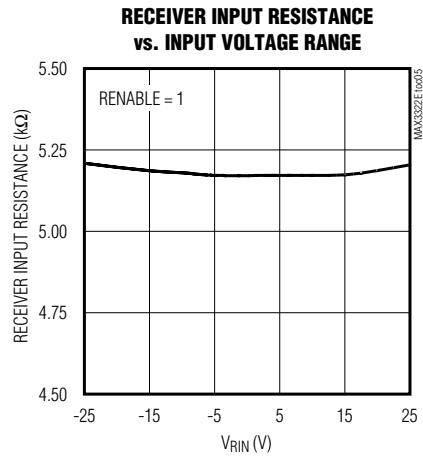
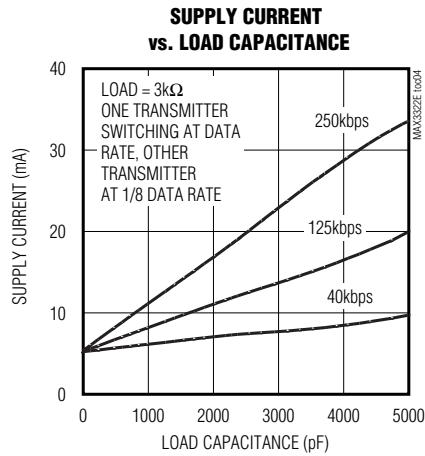
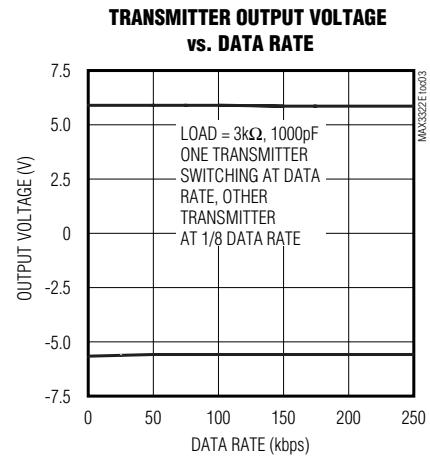
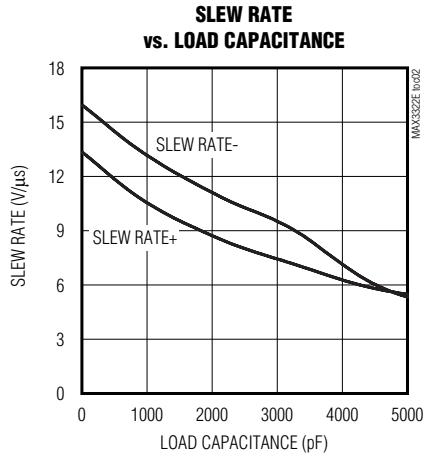
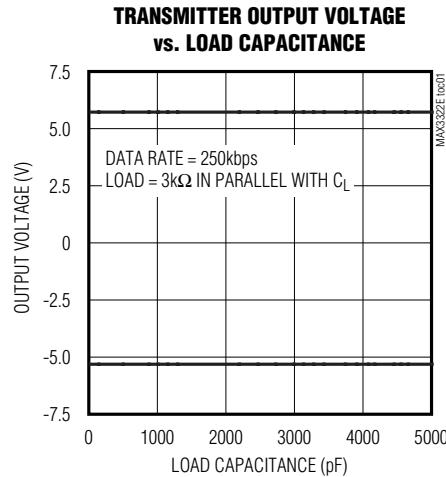
**Note 2:** Guaranteed by design. Not production tested.

**MAX3322E/MAX3323E**

## **$\pm 15\text{kV}$ ESD-Protected, RS-232 Transceivers for Multidrop Applications**

### **Typical Operating Characteristics**

( $V_{CC} = 3.3\text{V}$ ,  $V_L = 3.3\text{V}$ ,  $C1-C4 = 0.1\mu\text{F}$ ,  $T_A = +25^\circ\text{C}$ .)



# **$\pm 15\text{kV}$ ESD-Protected, RS-232 Transceivers for Multidrop Applications**

## **Pin Description**

<b>PIN</b>		<b>NAME</b>	<b>FUNCTION</b>
<b>MAX3322E</b>	<b>MAX3323E</b>		
1	1	C1+	Positive Terminal of the Voltage-Doubler Charge-Pump Capacitor
2	2	V+	+5.5V Generated by the Charge Pump
3	3	C1-	Negative Terminal of the Voltage-Doubler Charge-Pump Capacitor
4	4	C2+	Positive Terminal of the Inverting Charge-Pump Capacitor
5	5	C2-	Negative Terminal of the Inverting Charge-Pump Capacitor
6	6	V-	-5.5V Generated by the Charge Pump
7, 9	7	TOUT_	Transmitter Output
8, 10	8	RIN_	Receiver Input
11, 13	9	ROUT_	Receiver Output
12, 14	10	TIN_	Transmitter Input
15	11	TXENABLE	Transmitter Enable. Drive TXENABLE high to enable transmitter. Drive TXENABLE low to put transmitter into high impedance.
16	12	RENABLE	Receiver Termination Enable. Drive RENABLE high for normal RS-232 $5\text{k}\Omega$ termination. Drive RENABLE low to make receiver inputs high impedance. In either case, the receiver and its output are enabled.
17	13	$V_L$	Logic-Level Supply. All CMOS inputs and outputs are referred to $V_L$ , which is from 1.65V to 5.5V.
18	14	SHDN	Shutdown Input. Drive SHDN low to put device into shutdown mode. Drive SHDN high for normal operation. In shutdown, all transmitter and receiver outputs are in three-state; receiver inputs are high impedance.
19	15	GND	Ground
20	16	VCC	+3V to +5.5V Input Voltage. Bypass VCC to GND with a $0.1\mu\text{F}$ capacitor.

## **Detailed Description**

The MAX3322E/MAX3323E are RS-232 transceivers for multidrop applications (i.e., multiple-receiver operation). The devices are pin selectable between standard RS-232 operation with  $5\text{k}\Omega$  input resistance receivers or high-input-impedance receivers. Receivers of the MAX3322E/MAX3323E remain active in both modes of operation. In multidrop applications, a selected receiver is set at a  $5\text{k}\Omega$  input resistance, while the others are high-input impedance, maintaining RS-232 standards. Logic control permits selection of the functional mode: high impedance or normal load. The transmitters are enabled by logic control to allow transmission-line sharing.

The logic supply input ( $V_L$ ) controls the levels of the system's I/O and works from 1.65V to 5.5V, providing compatibility with lower microprocessor I/O voltages. The transmitters are inverting level translators that convert CMOS logic levels into RS-232-compatible levels. They guarantee 250kbps with loads of  $R_L = 3\text{k}\Omega$  and  $C_L$

=  $1000\text{pF}$ . The transmitters are enabled or disabled (three-stated) by the logic control TXENABLE, which manages transmission-line sharing in multidrop applications. When TXENABLE is high, the transmitter is enabled. When TXENABLE is low, the transmitter is put in high-impedance state. The receivers can be used in two conditions, selectable by the logic control RENABLE. When RENABLE is high, the internal  $5\text{k}\Omega$  resistor is connected across receiver input and ground. When RENABLE is low, the receiver input is high impedance, while maintaining receiving capability.

In shutdown mode, all transmitter and receiver outputs are three-stated, receiver inputs are in high impedance, the charge pump is turned off, V+ decays to VCC, and V- decays to ground. ESD protection structures are incorporated in all pins to protect against ESD events encountered during handling and assembly. The receiver inputs and the transmitter outputs have  $\pm 15\text{kV}$  ESD structure implementation.

**MAX3322E/MAX3323E**

## ***±15kV ESD-Protected, RS-232 Transceivers for Multidrop Applications***

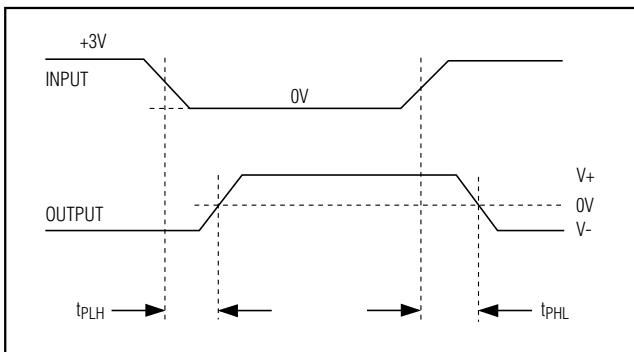


Figure 1. Transmitter Propagation-Delay Timing

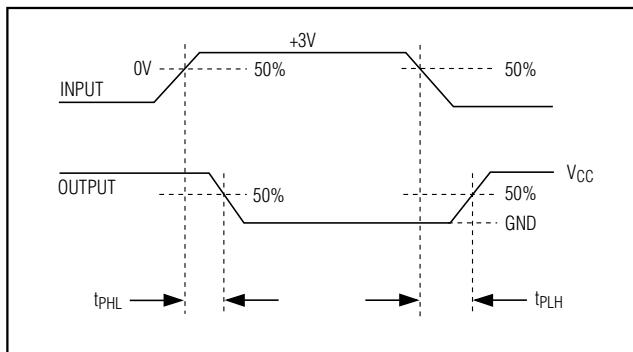


Figure 2. Receiver Propagation-Delay Timing

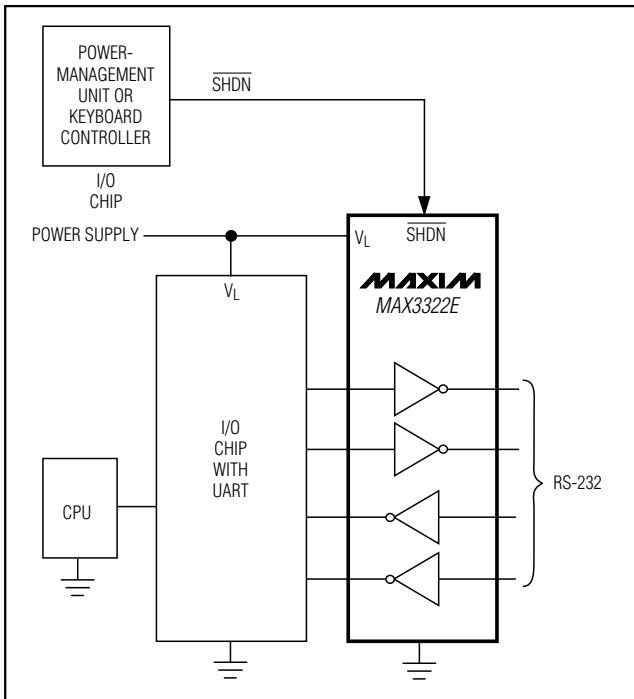


Figure 3. Interface Under Control of PMU

### **Dual Charge-Pump Voltage Converter**

The MAX3322E/MAX3323Es' internal power supply consists of a regulated dual charge pump that provides output voltages of +5.5V (doubling charge pump) and -5.5V (inverting charge pump), regardless of the input voltage ( $V_{CC}$ ), over a +3.0V to +5.5V range. The charge pumps operate in a discontinuous mode: if the output voltages are less than 5.5V, the charge pumps are enabled; if the output voltages exceed 5.5V, the charge pumps are disabled. Each charge pump requires a fly-

*LapLink* is a trademark of Traveling Software.

ing capacitor ( $C_1, C_2$ ) and reservoir capacitor ( $C_3, C_4$ ) to generate the  $V_+$  and  $V_-$  supplies. Because supply voltages can vary from +3V up to +5.5V, the selection of the capacitor values depends on the  $V_{CC}$  value. Table 2 shows minimum capacitor values.

### **RS-232 Transmitters**

The transmitters are inverting level translators that convert CMOS-logic levels to 5.0V EIA/TIA-232 levels. The transmitters are enabled or disabled (three-stated) by the logic control TXENABLE, which manages transmission-line sharing in multidrop applications. When TXENABLE is high, the transmitter is enabled. When TXENABLE is low, the transmitter is put in a high-impedance state (see Table 1).

The MAX3322E/MAX3323Es' transmitters guarantee a 250kbps data rate with worst-case loads of  $3k\Omega$  in parallel with 1000pF, providing compatibility with PC-to-PC communication software (such as LapLink™). Transmitters can be paralleled to drive multiple receivers or mice. Figure 3 shows a complete system connection.

### **RS-232 Receivers**

MAX3322E/MAX3323E receivers convert RS-232 signals to CMOS-logic output levels. The unique feature of the receivers is the switchable input resistance. The receiver input resistance can be  $5k\Omega$  or high impedance. These two conditions are selectable by the logic control RENABLE. When RENABLE is high, the  $5k\Omega$  resistor is connected across the receiver input and ground. When RENABLE is low, the receiver input is high impedance, maintaining receiving capability. This feature permits the design of multidrop applications, which observe RS-232 interface standards.

# ***±15kV ESD-Protected, RS-232 Transceivers for Multidrop Applications***

**Table 1. Tx/Rx Logic**

TXENABLE	RENABLE	SHDN	TRANSMITTER OUTPUT	RECEIVER OUTPUT	RECEIVER INPUT
1	1	0	High-Z	High-Z	High-Z
1	1	1	Active	Enabled	$5k\Omega$
1	0	0	High-Z	High-Z	High-Z
1	0	1	Active	Enabled	High-Z
0	1	0	High-Z	High-Z	High-Z
0	1	1	High-Z	Enabled	$5k\Omega$
0	0	0	High-Z	High-Z	High-Z
0	0	1	High-Z	Enabled	High-Z

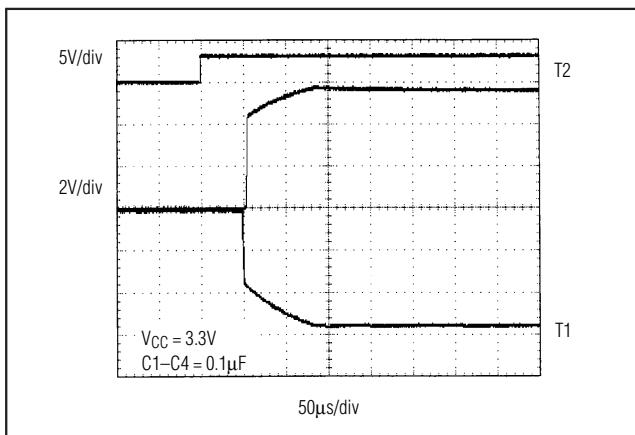


Figure 4. Transmitter Outputs when Exiting Shutdown

High-input impedance is guaranteed from -13.0V to +13.0V, when the receiver is in high-input-impedance mode. The receiver is able to withstand the RS-232 maximum input voltage of ±25V.

## **Shutdown Mode**

Supply current falls to less than 10µA when the MAX3322E/MAX3323E are placed in shutdown mode (logic low). When in shutdown mode, the devices' charge pumps are turned off, V+ decays to VCC, V- is pulled to ground, the transmitter outputs and the receiver outputs are disabled (high impedance), and the receiver inputs are in high impedance (Table 1). The device enters shutdown when VL or VCC is absent.

The time required to exit shutdown is typically 50µs, as shown in Figure 4. Connect SHDN to VCC if shutdown mode is not used.

## **VL Logic Supply Input**

Unlike other RS-232 interface devices, in which the receiver outputs swing between 0 and VCC, the MAX3322E/MAX3323E feature a separate logic supply input (VL) that sets VOUT for the receiver outputs and sets thresholds for the transmit and shutdown inputs. This feature allows a great deal of flexibility in interfacing to many types of systems with different logic levels. Connect this input to the host logic supply ( $1.65V \leq VL \leq 5.5V$ ).

## **±15kV ESD Protection**

To protect the MAX3322E/MAX3323E against ESD, transmitters and receivers have extra protection against static electricity to protect the device up to ±15kV. The ESD structures withstand high ESD in all states: normal operation, shutdown, and powered down. ESD protection can be tested in various ways; the transmitter and receiver pins are characterized for protection to the following limits:

- ±15kV using the Human Body Model
- ±8kV using the IEC 1000-4-2 Contact Discharge method
- ±15kV using the IEC 1000-4-2 Air-Gap method

**Note:** ESD performance depends on many conditions. Contact Maxim for a reliability report that documents test setup, test methodology, and test results.

## **Human Body Model**

Figure 5 shows the Human Body Model, and Figure 6 shows the current waveform it generates when discharged into a low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the test device through a  $1.5k\Omega$  resistor.

**MAX3322E/MAX3323E**

## ***±15kV ESD-Protected, RS-232 Transceivers for Multidrop Applications***

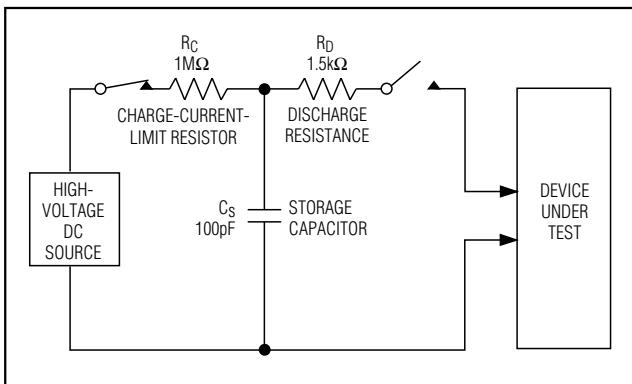


Figure 5. Human Body ESD Test Model

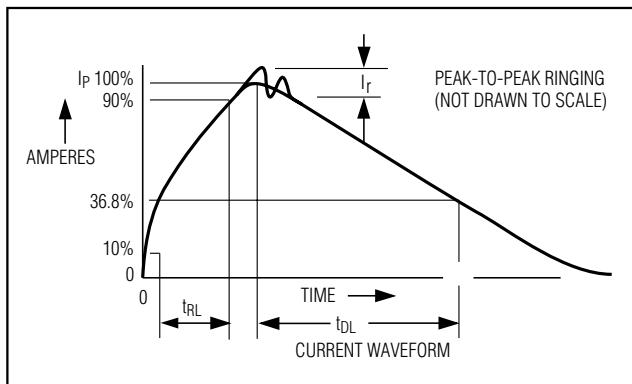


Figure 6. Human Body Model Current Waveform

### ***IEC 1000-4-2***

The IEC 1000-4-2 standard covers ESD testing and performance of finished equipment; it does not refer specifically to integrated circuits. The MAX3322E/MAX3323E help the user design equipment that meets level 4 of IEC 1000-4-2, without the need for additional ESD-protection components. The major difference between tests done using the Human Body Model and IEC 1000-4-2 is a higher peak current in IEC 1000-4-2, because series resistance is lower in the IEC 1000-4-2 model. Hence, the ESD withstand voltage measured to IEC 1000-4-2 is generally lower than that measured using the Human Body Model. Figure 7 shows the IEC 1000-4-2 model. Figure 8 shows the current waveform it generates when discharged into a low impedance. The Air-Gap Discharge test involves approaching the device with a charged probe. The Contact Discharge method connects the probe to the device before the probe is energized.

### ***Machine Model***

The Machine Model for ESD tests all pins using a 200pF storage capacitor and zero discharge resistance. Its objective is to emulate the stress caused by contact that occurs with handling and assembly during manufacturing. All pins require this protection during manufacturing. Therefore, after PC board assembly, the Machine Model is less relevant to I/O ports.

### ***Applications Information***

The capacitor type used for C1–C4 is not critical for proper operation; polarized or nonpolarized capacitors can be used. The charge pump requires 0.1μF capacitors for 3.3V operation. For other supply voltages, see Table 2 for required capacitor values. Do not use values smaller than those listed in Table 2. Increasing the capacitor values (e.g., by a factor of 2) reduces ripple

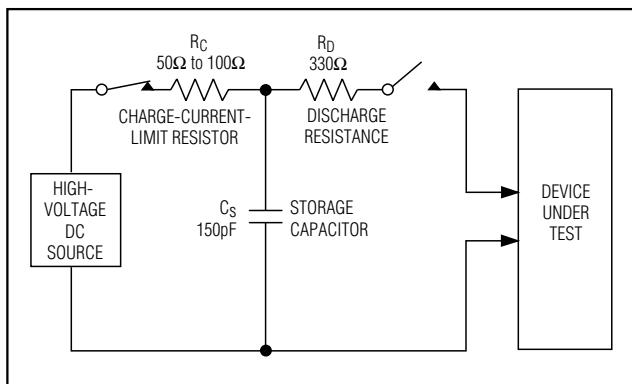


Figure 7. IEC 1000-4-2 ESD Test Model

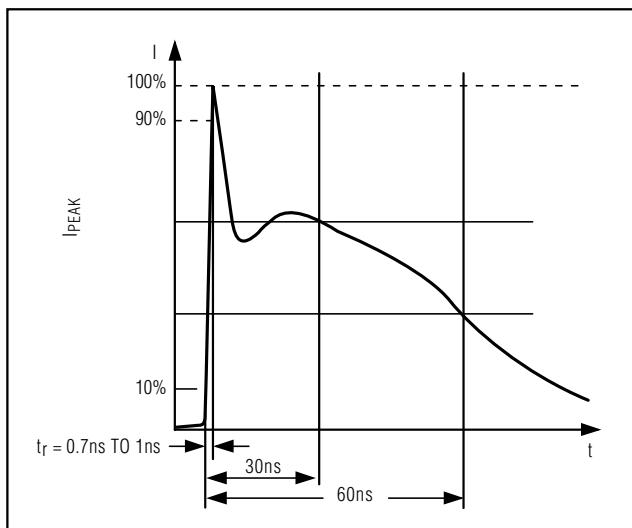


Figure 8. IEC 1000-4-2 ESD Generator Current Waveform

# **$\pm 15kV$ ESD-Protected, RS-232 Transceivers for Multidrop Applications**

on the transmitter outputs and slightly reduces power consumption. The values of C2, C3, and C4 can be increased without changing C1's value. However, do not increase C1's value without also increasing the values of C2, C3, and C4 to maintain the proper ratios (C1 to the other capacitors).

When using the minimum required capacitor values, make sure the capacitor value does not degrade excessively with temperature. If in doubt, use capacitors with a larger nominal value. The capacitor's equivalent series resistance (ESR), which usually rises at low temperatures, influences the amount of ripple on V+ and V-.

**Table 2. Minimum Required Capacitor Values**

<b>V<sub>cc</sub> (V)</b>	<b>C1 (μF)</b>	<b>C2, C3, C4 (μF)</b>
3.0 to 3.6	0.1	0.1
4.5 to 5.5	0.047	0.33
3.0 to 5.5	0.22	1

## **Multidrop Applications**

The MAX3323E connects to the RS-232 serial port of computer peripherals such as a bar-code scanner, video security controls, industrial multimeters, etc., and allows multiple devices to share the same communication cable connected to a PC.

Figure 9 shows a PC UART transmitting to a single receiver with a  $5k\Omega$  termination resistor while the other receivers remain in a high-impedance state. When the receiver inputs are high impedance, they remain active and maintain receiving capability. This feature permits the design of multidrop applications, which observe the RS-232 interface standard.

Transmitters are enabled and disabled through TXENABLE, allowing the sharing of a single bus line. Transmitters are high impedance when disabled. The host PC's transmitter stays enabled at all times. Only one peripheral transmitter remains enabled at any time. If the host PC wants to communicate with another peripheral, it first must tell the current peripheral to deassert its transmitter.

**MAX3322E/MAX3323E**

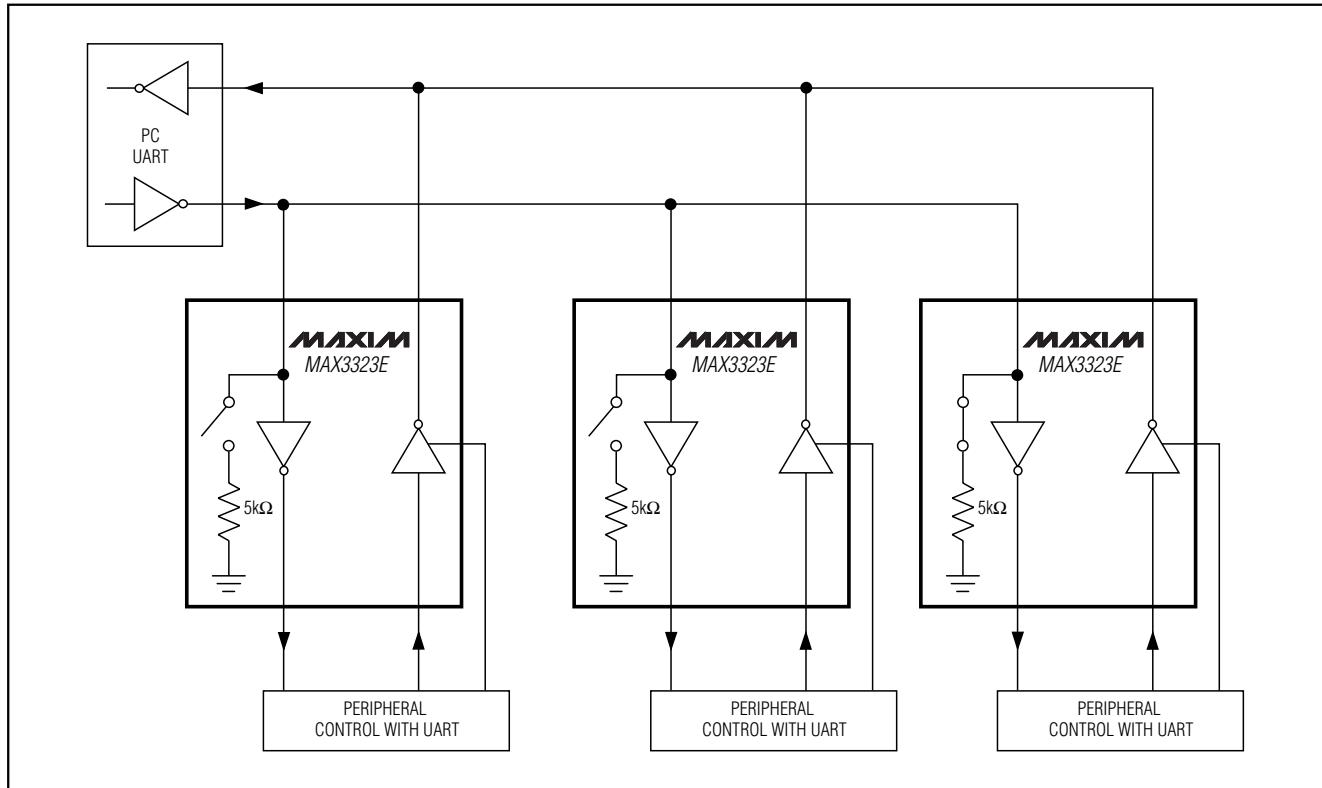


Figure 9. Multidrop Application

## ***±15kV ESD-Protected, RS-232 Transceivers for Multidrop Applications***

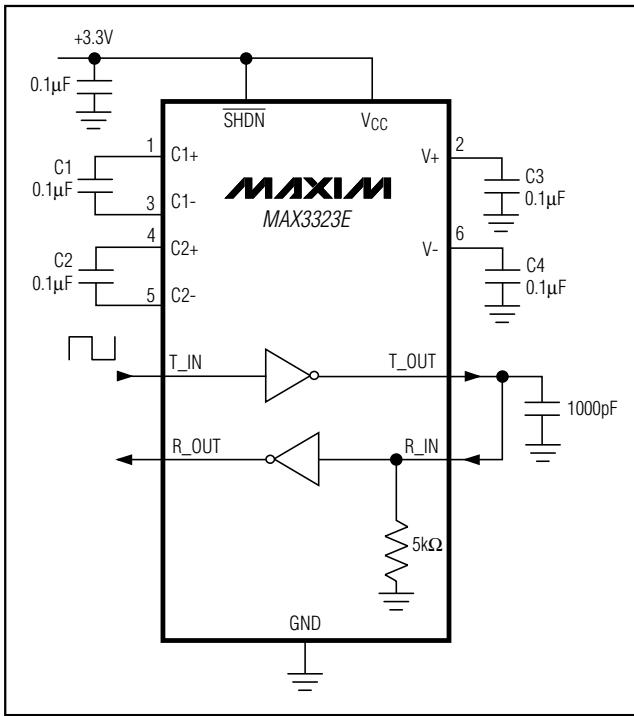


Figure 10. Loopback Test Circuit

**Power-Supply Decoupling**  
 In most circumstances, a  $0.1\mu\text{F}$  bypass capacitor is adequate. In applications sensitive to power-supply noise, decouple  $V_{CC}$  to ground with a capacitor of the same value as charge-pump capacitor C1. Connect bypass capacitors as close to the IC as possible.

### **High Data Rates**

The MAX3322E/MAX3323E maintain the RS-232  $\pm 5.0\text{V}$  minimum transmitter output voltage even at high data rates. Figure 10 shows a transmitter loopback test circuit. Figure 11 shows a loopback test result at 125kbps, and Figure 12 shows the same test at 250kbps. For Figure 11, all transmitters were driven simultaneously at 125kbps into RS-232 loads in parallel with  $1000\text{pF}$ . For Figure 12, a single transmitter was driven at 250kbps, and all transmitters were loaded with an RS-232 receiver in parallel with  $1000\text{pF}$ .

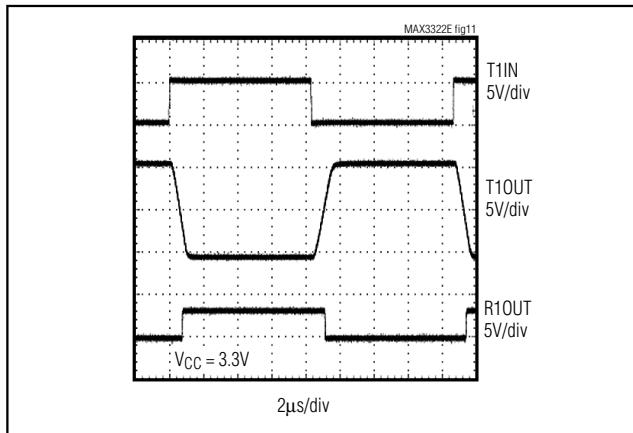


Figure 11. Loopback Test Results at 125kbps

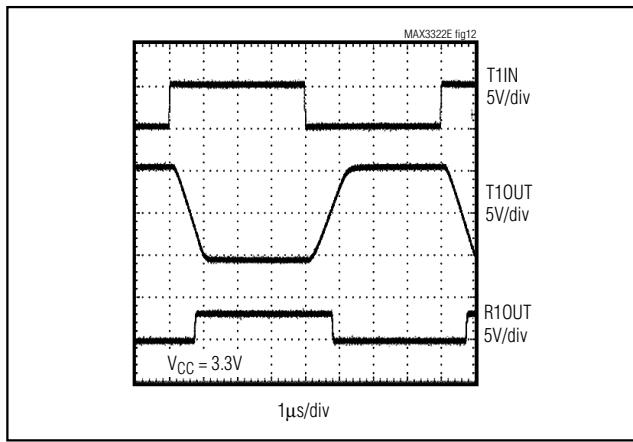


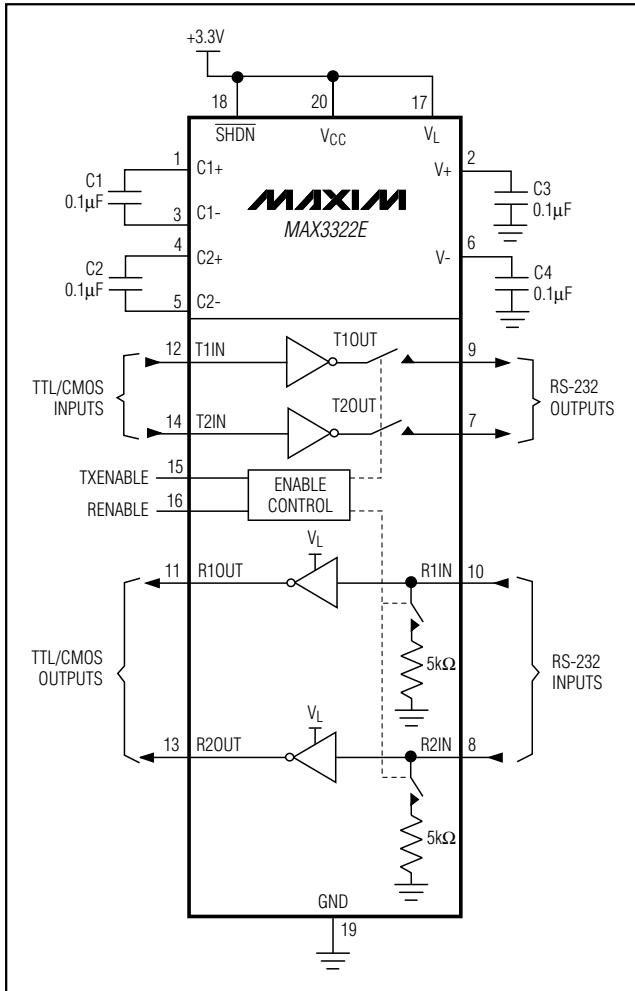
Figure 12. Loopback Test Results at 250kbps

### **Interconnection with 3V and 5V Logic**

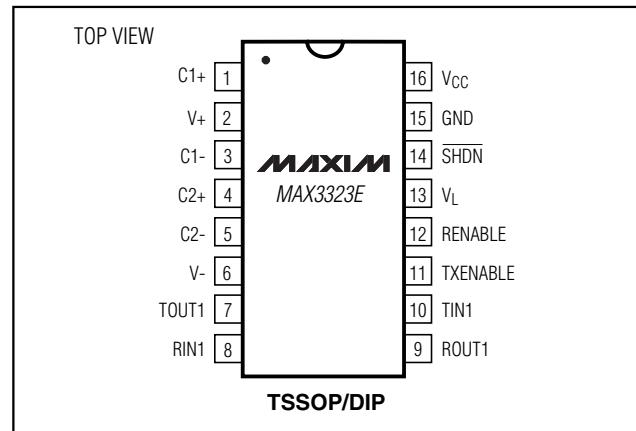
The MAX3322E/MAX3323E can directly interface with various 5V logic families, including ACT and HCT CMOS. The logic voltage power-supply pin  $V_L$  sets the output voltage level of the receivers and the input thresholds of the transmitters.

# **$\pm 15kV$ ESD-Protected, RS-232 Transceivers for Multidrop Applications**

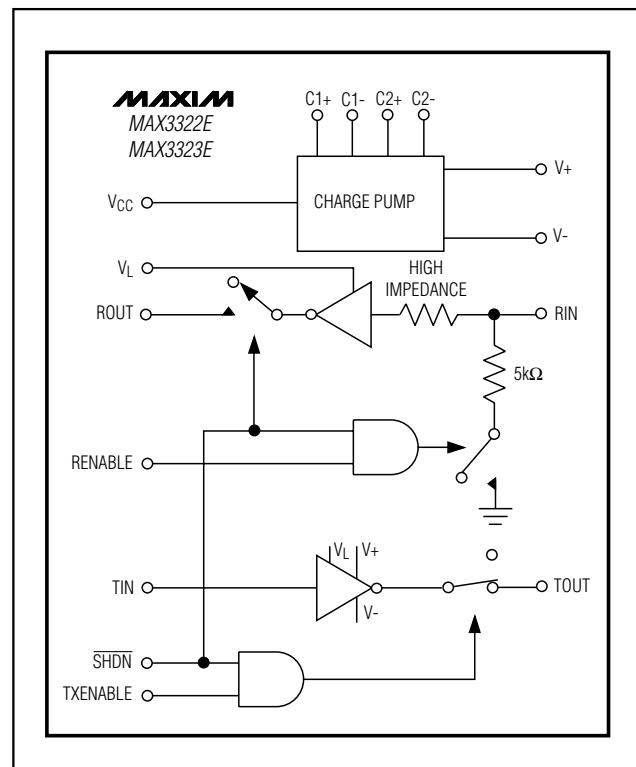
## **Typical Operating Circuit**



## **Pin Configurations (continued)**



## **Functional Diagram**



## **Chip Information**

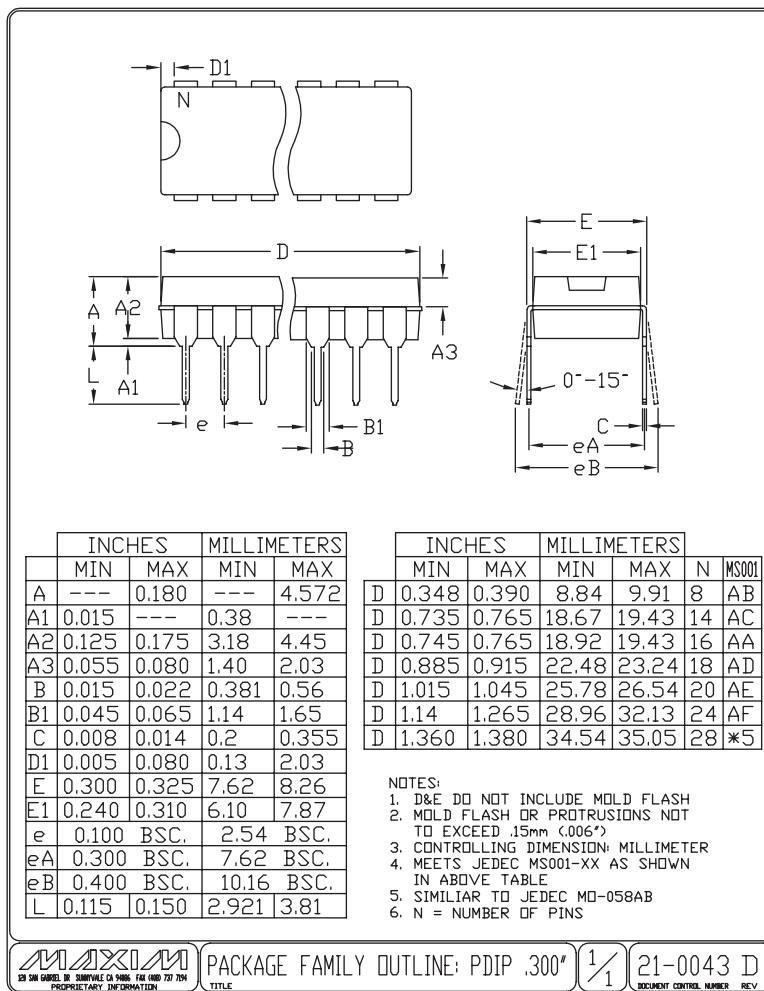
TRANSISTOR COUNT: 1294

PROCESS: BiCMOS

# **±15kV ESD-Protected, RS-232 Transceivers for Multidrop Applications**

## **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).)



MAXIM  
12 SAN GABRIEL DR. SANTA CLARA, CA 95051 FAX (408) 727-7094  
PROPRIETARY INFORMATION

PACKAGE FAMILY OUTLINE: PDIP .300"

1/1

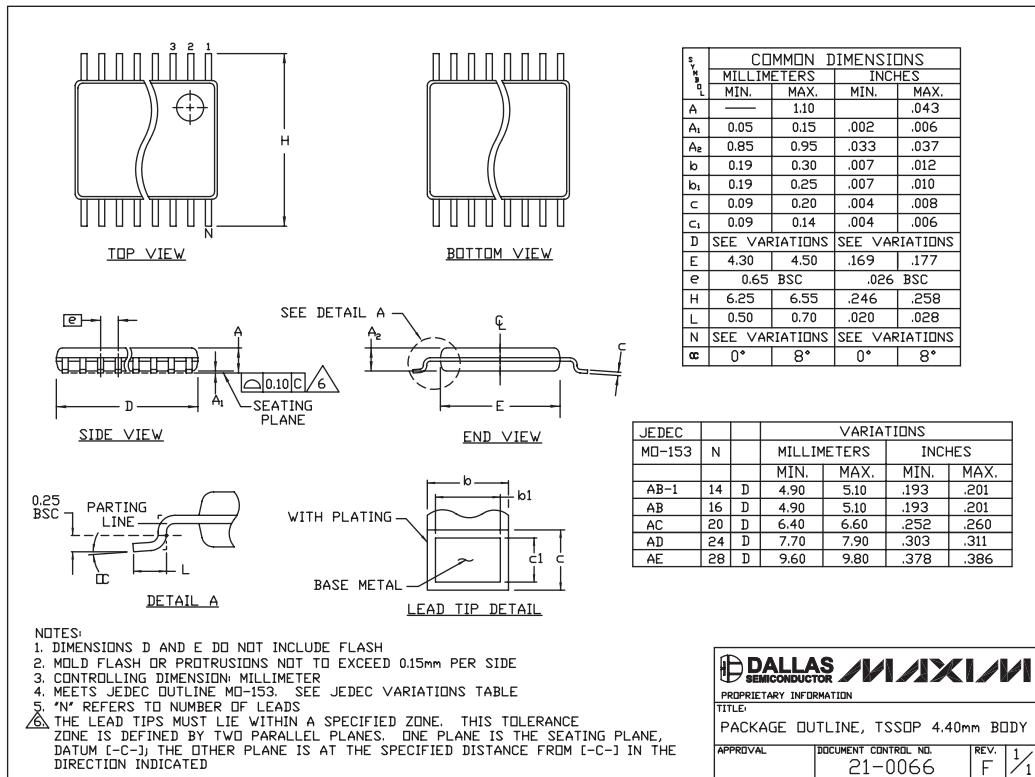
21-0043 D

DOCUMENT CONTROL NUMBER REV

# **±15kV ESD-Protected, RS-232 Transceivers for Multidrop Applications**

## **Package Information (continued)**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).)



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**MAX3322E/MAX3323E**